



42390P12897

C/m
6-27-03

PATENT

7/a
T. Scott
7-11-03

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Dias, et al.

Serial No.: 10/000,229

Filed: November 30, 2001

For: BACKSIDE METALLIZATION ON
SIDES OF MICROELECTRONIC
DICE FOR EFFECT THERMAL
CONTACT WITH HEAT
DISSIPATION DEVICES

Examiner: Hoai V. Pham

Group Art Unit: 2814

Attorney Docket No.: 42390P12897

CERTIFICATE OF MAILING

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6/27/03
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DEBORAH L. HIGMAN
Typed/printed name of person whose signature is contained above

AMENDMENT

Hon. Assistant Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the February 27, 2003 Office Action with the time of response having been extended by one month, please consider the following amendments and remarks.

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